

Hearables

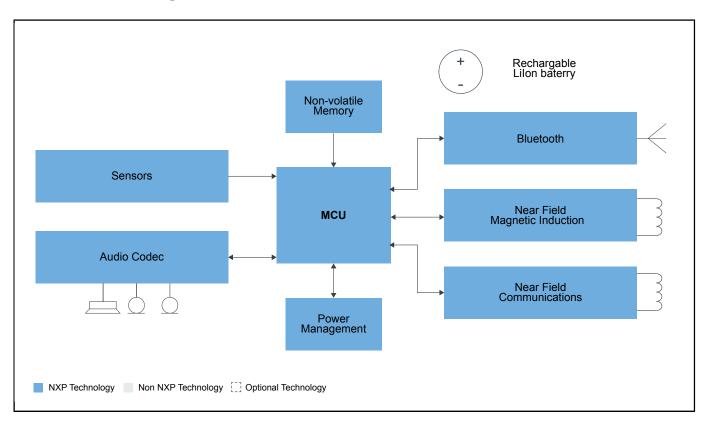
Last Updated: Dec 9, 2021

Hearables, or smart headphones, are highly integrated, truly wireless earbuds designed to improve audio experiences across a range of consumer and healthcare applications.

Small form factors, ultra-lightweight, and wireless operation increase user comfort. The continued challenge for hearables is how to combine audio quality, user experience, and better battery life in a tiny package while offering a multitude of possibilities, all of which demands digital signal processing.

NXP® offers a growing portfolio of ultra-low-power MiGLO™ hearables solutions based on digital signal processing, NFMI and Bluetooth® Low-Energy technologies. MiGLO delivers the power of wireless audio today.

Hearables Block Diagram



Recommended Products for Hearables	
мси	LPC541XX: Low-Power Microcontrollers (MCUs) Based on Arm® Cortex®-M4 Cores With Optional Cortex®-M0+ Coprocessor i.MX RT500 Crossover MCU with Arm® Cortex®-M33, DSP and GPU Cores i.MX RT600 Crossover MCU with Arm® Cortex®-M33 and DSP Cores
Power Management	PCA9420: PMIC for Low Power Applications Battery Management: Battery Management
NFC	NFC (HF): NFC - Near Field Communication
Memory	NXH5104UK: 4 Mbit Serial SPI EEPROM
NFMI Radio	• MiGLO®: MiGLO®
Sensors	MMA8451Q: ±2g/±4g/±8g, Low g, 14-bit Digital Accelerometer FXOS8700CQ: Digital Motion Sensor - 3D Accelerometer (±2g/±4g/±8g) + 3D Magnetometer
Bluetooth	NXH3670: Ultra-low Power, Low Latency Audio for Wireless Gaming Headphone
Audio Codec	SGTL5000: Ultra-Low-Power Audio Codec

View our complete solution for Hearables.

Note: The information on this document is subject to change without notice.

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